

# FDMC8884

## N-Channel Power Trench® MOSFET 30 V, 15 A, 19 mΩ

### Features

- Max  $r_{DS(on)}$  = 19 mΩ at  $V_{GS} = 10$  V,  $I_D = 9.0$  A
- Max  $r_{DS(on)}$  = 30 mΩ at  $V_{GS} = 4.5$  V,  $I_D = 7.2$  A
- High performance technology for extremely low  $r_{DS(on)}$
- Termination is Lead-free and RoHS Compliant

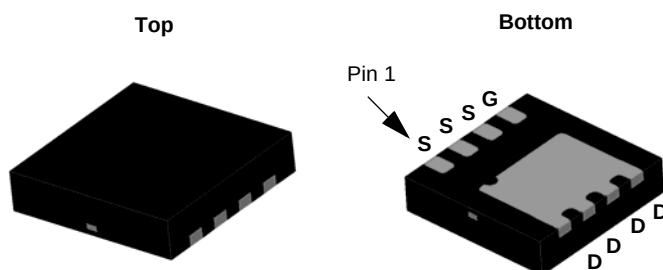


### General Description

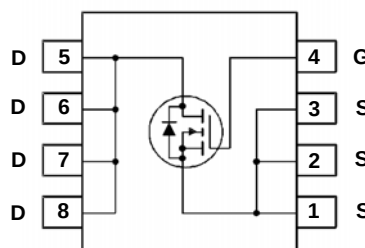
This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench® process that has been especially tailored to minimize the on-state resistance. This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.

### Application

- High side in DC - DC Buck Converters
- Notebook battery power management
- Load switch in Notebook



MLP 3.3x3.3



### MOSFET Maximum Ratings $T_A = 25^\circ\text{C}$ unless otherwise noted

| Symbol         | Parameter                                                            | Ratings     | Units            |
|----------------|----------------------------------------------------------------------|-------------|------------------|
| $V_{DS}$       | Drain to Source Voltage                                              | 30          | V                |
| $V_{GS}$       | Gate to Source Voltage                                               | $\pm 20$    | V                |
| $I_D$          | Drain Current -Continuous (Package limited) $T_C = 25^\circ\text{C}$ | 15          | A                |
|                | -Continuous (Silicon limited) $T_C = 25^\circ\text{C}$               | 24          |                  |
|                | -Continuous $T_A = 25^\circ\text{C}$ (Note 1a)                       | 9.0         |                  |
|                | -Pulsed                                                              | 40          |                  |
| $E_{AS}$       | Single Pulse Avalanche Energy (Note 3)                               | 24          | mJ               |
| $P_D$          | Power Dissipation $T_C = 25^\circ\text{C}$                           | 18          | W                |
|                | Power Dissipation $T_A = 25^\circ\text{C}$ (Note 1a)                 | 2.3         |                  |
| $T_J, T_{STG}$ | Operating and Storage Junction Temperature Range                     | -55 to +150 | $^\circ\text{C}$ |

### Thermal Characteristics

|                 |                                                   |     |                    |
|-----------------|---------------------------------------------------|-----|--------------------|
| $R_{\theta JC}$ | Thermal Resistance, Junction to Case              | 6.6 | $^\circ\text{C/W}$ |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient (Note 1a) | 53  |                    |

### Package Marking and Ordering Information

| Device Marking | Device   | Package     | Reel Size | Tape Width | Quantity   |
|----------------|----------|-------------|-----------|------------|------------|
| FDMC8884       | FDMC8884 | MLP 3.3x3.3 | 13 "      | 12 mm      | 3000 units |

**Electrical Characteristics**  $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise noted

| Symbol | Parameter | Test Conditions | Min | Typ | Max | Units |
|--------|-----------|-----------------|-----|-----|-----|-------|
|--------|-----------|-----------------|-----|-----|-----|-------|

**Off Characteristics**

|                                      |                                           |                                                                                       |    |    |           |                        |
|--------------------------------------|-------------------------------------------|---------------------------------------------------------------------------------------|----|----|-----------|------------------------|
| $BV_{DSS}$                           | Drain to Source Breakdown Voltage         | $I_D = 250\text{ }\mu\text{A}$ , $V_{GS} = 0\text{ V}$                                | 30 |    |           | V                      |
| $\frac{\Delta BV_{DSS}}{\Delta T_J}$ | Breakdown Voltage Temperature Coefficient | $I_D = 250\text{ }\mu\text{A}$ , referenced to $25\text{ }^{\circ}\text{C}$           |    | 22 |           | mV/ $^{\circ}\text{C}$ |
| $I_{DSS}$                            | Zero Gate Voltage Drain Current           | $V_{DS} = 24\text{ V}$ , $V_{GS} = 0\text{ V}$<br>$T_J = 125\text{ }^{\circ}\text{C}$ |    |    | 1<br>250  | $\mu\text{A}$          |
| $I_{GSS}$                            | Gate to Source Leakage Current            | $V_{GS} = \pm 20\text{ V}$ , $V_{DS} = 0\text{ V}$                                    |    |    | $\pm 100$ | nA                     |

**On Characteristics**

|                                        |                                                          |                                                                                     |     |     |     |                        |
|----------------------------------------|----------------------------------------------------------|-------------------------------------------------------------------------------------|-----|-----|-----|------------------------|
| $V_{GS(th)}$                           | Gate to Source Threshold Voltage                         | $V_{GS} = V_{DS}$ , $I_D = 250\text{ }\mu\text{A}$                                  | 1.4 | 1.9 | 2.5 | V                      |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate to Source Threshold Voltage Temperature Coefficient | $I_D = 250\text{ }\mu\text{A}$ , referenced to $25\text{ }^{\circ}\text{C}$         |     | -6  |     | mV/ $^{\circ}\text{C}$ |
| $r_{DS(on)}$                           | Static Drain to Source On Resistance                     | $V_{GS} = 10\text{ V}$ , $I_D = 9.0\text{ A}$                                       |     | 16  | 19  | m $\Omega$             |
|                                        |                                                          | $V_{GS} = 4.5\text{ V}$ , $I_D = 7.2\text{ A}$                                      |     | 22  | 30  |                        |
|                                        |                                                          | $V_{GS} = 10\text{ V}$ , $I_D = 9.0\text{ A}$ , $T_J = 125\text{ }^{\circ}\text{C}$ |     | 22  | 30  |                        |
| $g_{FS}$                               | Forward Transconductance                                 | $V_{DD} = 5\text{ V}$ , $I_D = 9.0\text{ A}$                                        |     | 24  |     | S                      |

**Dynamic Characteristics**

|           |                              |                                                                        |  |     |     |          |
|-----------|------------------------------|------------------------------------------------------------------------|--|-----|-----|----------|
| $C_{iss}$ | Input Capacitance            | $V_{DS} = 15\text{ V}$ , $V_{GS} = 0\text{ V}$ ,<br>$f = 1\text{ MHz}$ |  | 513 | 685 | pF       |
| $C_{oss}$ | Output Capacitance           |                                                                        |  | 110 | 150 | pF       |
| $C_{rss}$ | Reverse Transfer Capacitance |                                                                        |  | 76  | 115 | pF       |
| $R_g$     | Gate Resistance              |                                                                        |  | 1.4 | 2.1 | $\Omega$ |

**Switching Characteristics**

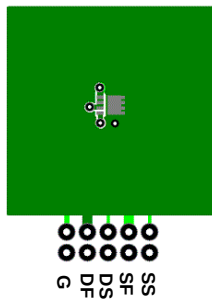
|              |                               |                                                                                                         |                                                  |     |     |    |
|--------------|-------------------------------|---------------------------------------------------------------------------------------------------------|--------------------------------------------------|-----|-----|----|
| $t_{d(on)}$  | Turn-On Delay Time            | $V_{DD} = 15\text{ V}$ , $I_D = 9.0\text{ A}$ ,<br>$V_{GS} = 10\text{ V}$ , $R_{GEN} = 6\text{ }\Omega$ |                                                  | 6   | 12  | ns |
| $t_r$        | Rise Time                     |                                                                                                         |                                                  | 2   | 10  | ns |
| $t_{d(off)}$ | Turn-Off Delay Time           |                                                                                                         |                                                  | 15  | 27  | ns |
| $t_f$        | Fall Time                     |                                                                                                         |                                                  | 2   | 10  | ns |
| $Q_{g(TOT)}$ | Total Gate Charge             | $V_{GS} = 0\text{ V to }10\text{ V}$                                                                    | $V_{DD} = 15\text{ V}$ ,<br>$I_D = 9.0\text{ A}$ | 10  | 14  | nC |
|              | Total Gate Charge             | $V_{GS} = 0\text{ V to }4.5\text{ V}$                                                                   |                                                  | 5.0 | 7.0 | nC |
| $Q_{gs}$     | Total Gate Charge             |                                                                                                         |                                                  | 1.8 |     | nC |
| $Q_{gd}$     | Gate to Drain "Miller" Charge |                                                                                                         |                                                  | 2.2 |     | nC |

**Drain-Source Diode Characteristics**

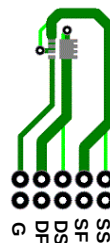
|          |                                       |                                                           |  |      |     |    |
|----------|---------------------------------------|-----------------------------------------------------------|--|------|-----|----|
| $V_{SD}$ | Source to Drain Diode Forward Voltage | $V_{GS} = 0\text{ V}$ , $I_S = 9.0\text{ A}$ (Note 2)     |  | 0.86 | 1.2 | V  |
|          |                                       | $V_{GS} = 0\text{ V}$ , $I_S = 1.6\text{ A}$ (Note 2)     |  | 0.76 | 1.2 |    |
| $t_{rr}$ | Reverse Recovery Time                 | $I_F = 9.0\text{ A}$ , $di/dt = 100\text{ A}/\mu\text{s}$ |  | 13   | 18  | ns |
| $Q_{rr}$ | Reverse Recovery Charge               |                                                           |  | 3    | 10  | nC |

## NOTES:

1.  $R_{\theta JA}$  is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



a. 53  $^{\circ}\text{C/W}$  when mounted on a 1 in<sup>2</sup> pad of 2 oz copper



b. 125  $^{\circ}\text{C/W}$  when mounted on a minimum pad of 2 oz copper

2. Pulse Test: Pulse Width < 300  $\mu\text{s}$ , Duty cycle < 2.0 %.

3.  $E_{AS}$  of 24 mJ is based on starting  $T_J = 25\text{ }^{\circ}\text{C}$ ,  $L = 1\text{ mH}$ ,  $I_{AS} = 7\text{ A}$ ,  $V_{DD} = 30\text{ V}$ ,  $V_{GS} = 10\text{ V}$ . 100% test at  $L = 3\text{ mH}$ ,  $I_{AS} = 4\text{ A}$ .

# Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

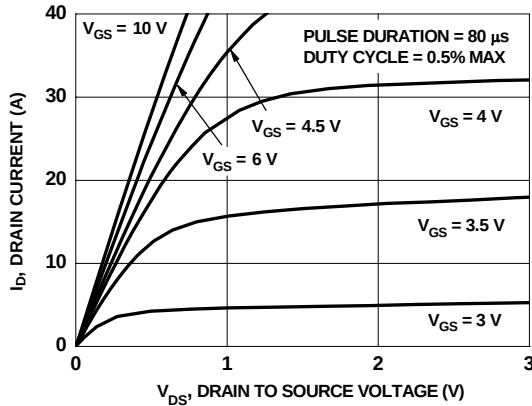


Figure 1. On-Region Characteristics

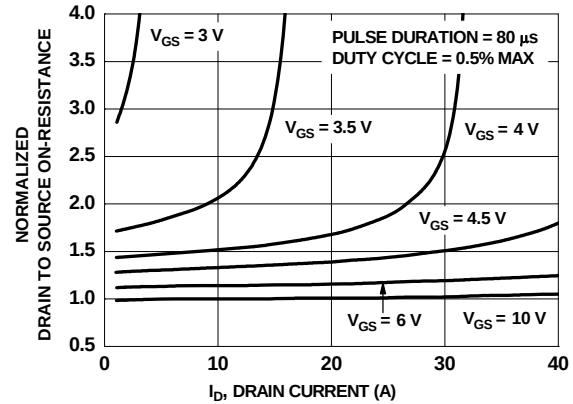


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

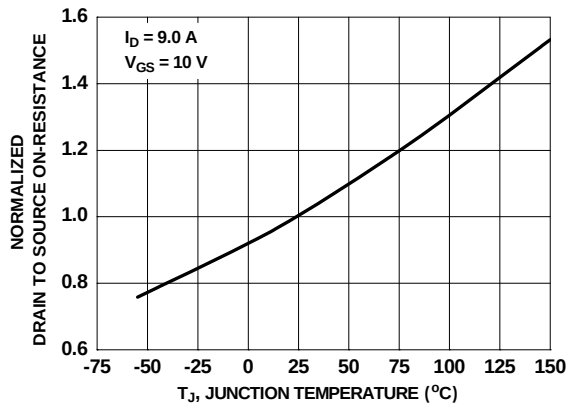


Figure 3. Normalized On-Resistance vs Junction Temperature

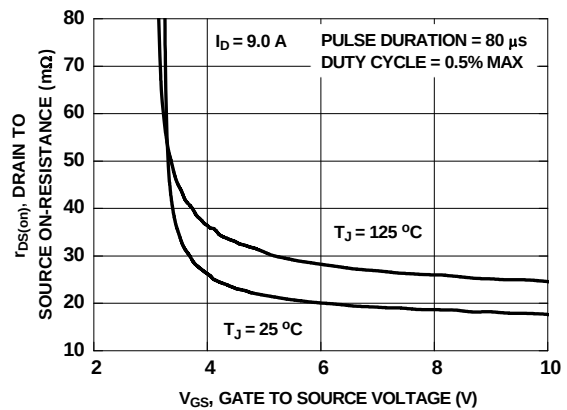


Figure 4. On-Resistance vs Gate to Source Voltage

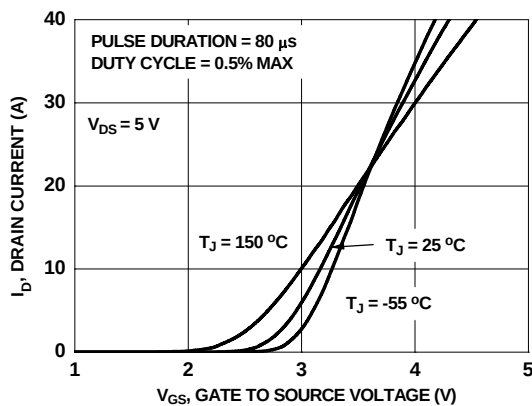


Figure 5. Transfer Characteristics

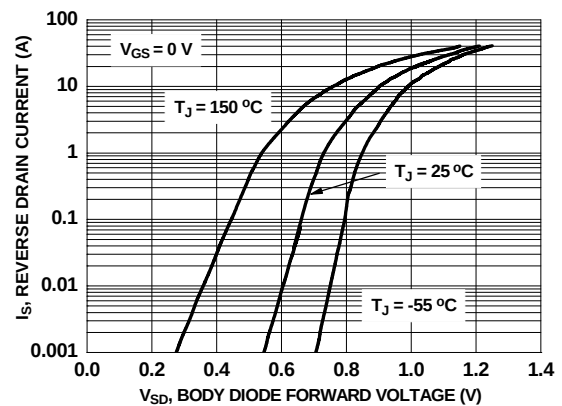


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

## Typical Characteristics $T_J = 25^\circ\text{C}$ unless otherwise noted

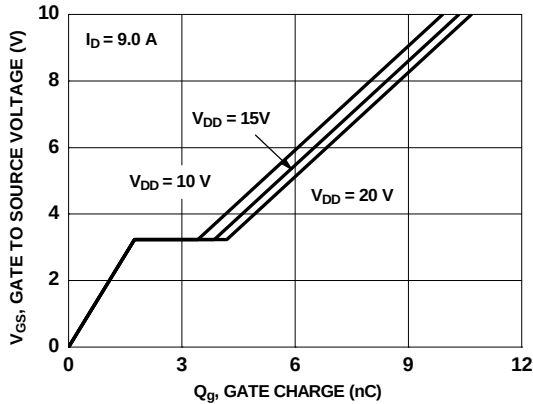


Figure 7. Gate Charge Characteristics

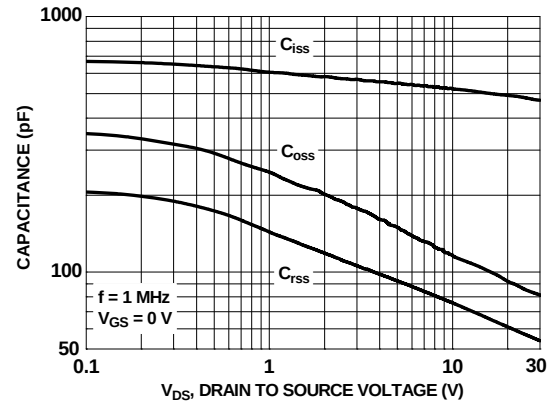


Figure 8. Capacitance vs Drain to Source Voltage

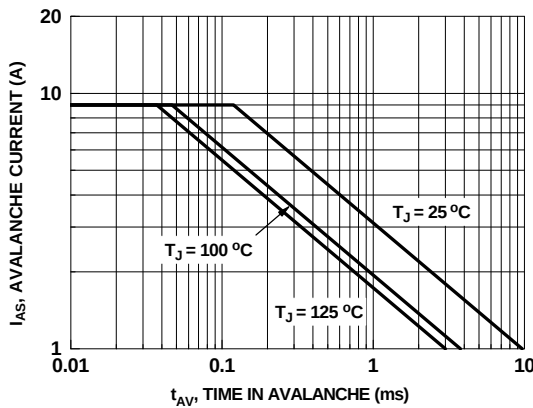


Figure 9. Unclamped Inductive Switching Capability

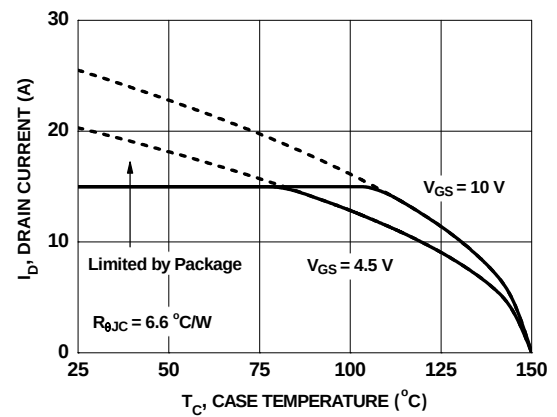


Figure 10. Maximum Continuous Drain Current vs Case Temperature

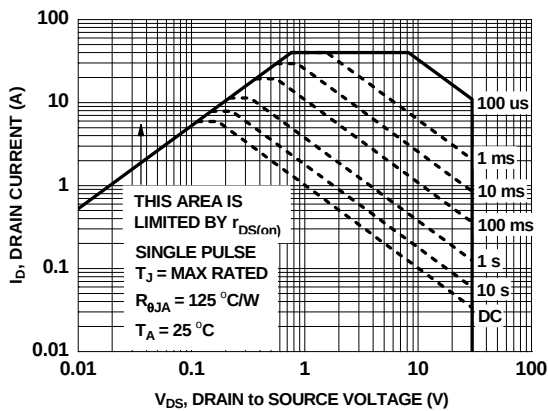


Figure 11. Forward Bias Safe Operating Area

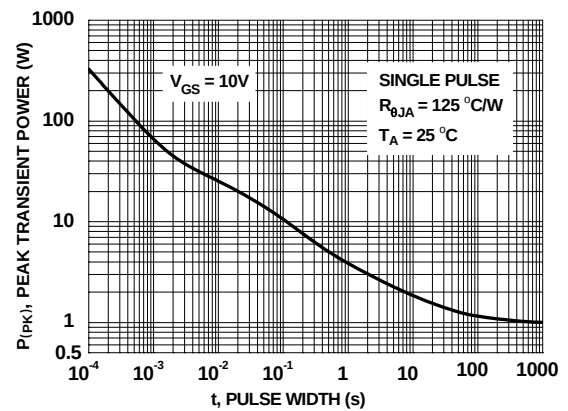
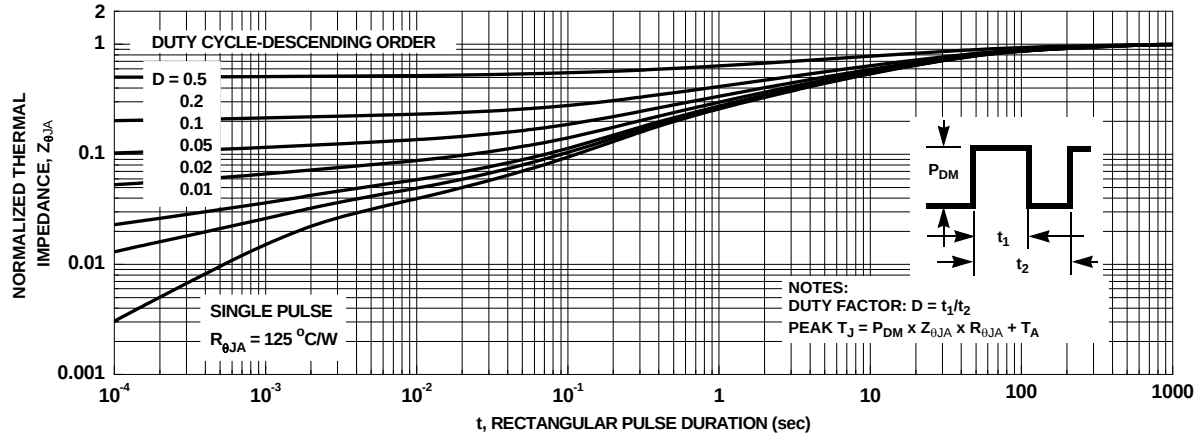
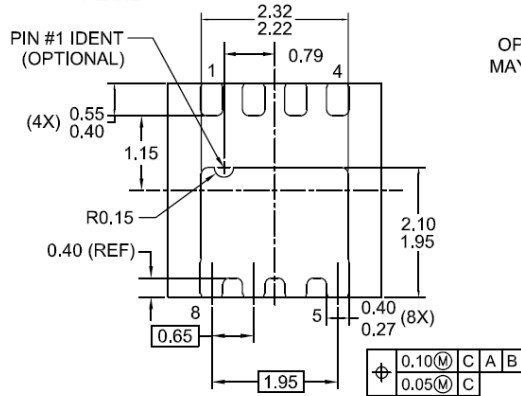
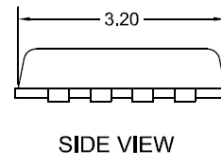
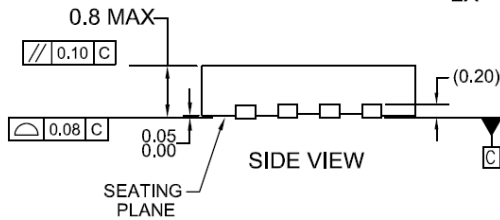
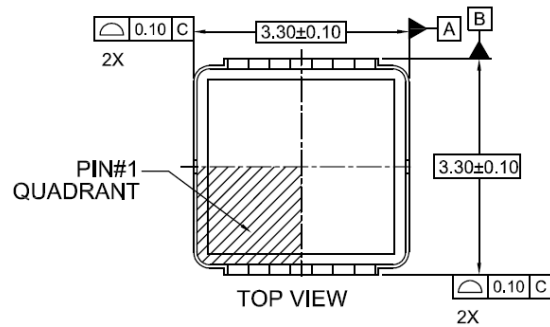
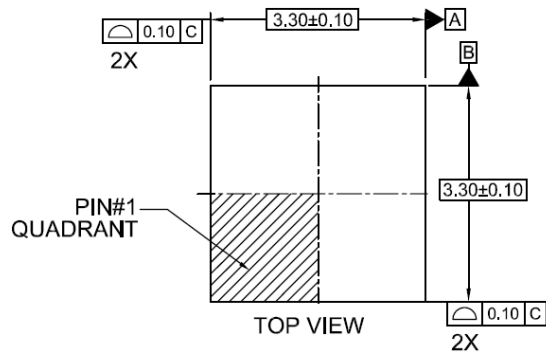


Figure 12. Single Pulse Maximum Power Dissipation

**Typical Characteristics**  $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise noted

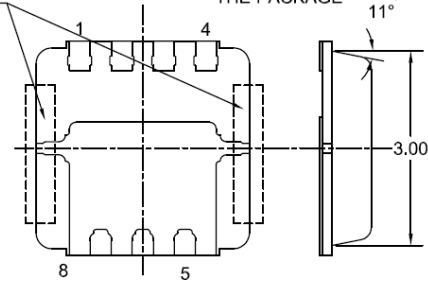


# Dimensional Outline and Pad Layout

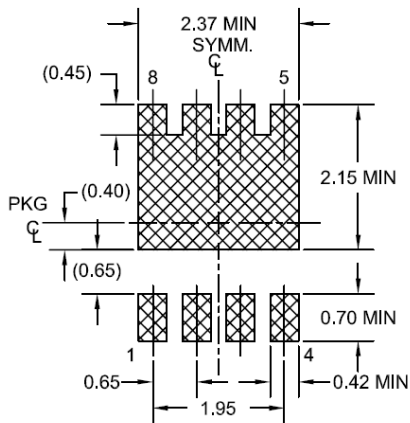


OPTIONAL - TIE BARS MAY APPEAR IN THESE AREAS

OPTIONAL - DRAFT ANGLE MAY APPEAR ON ALL 4 SIDES OF THE PACKAGE



ALL DIMENSIONS AS PER OPTION A UNLESS SPECIFIED



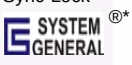
## NOTES:

- PACKAGE DOES NOT FULLY CONFORM TO JEDEC REGISTRATION MO-240.
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
- DIMENSIONS DOES NOT INCLUDE BURRS OR MOLD FLASH. BURRS OR MOLD FLASH SHALL NOT EXCEED 0.10MM.
- LAND PATTERN RECOMMENDATION IS BASED ON FSC DESIGN ONLY.



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|-----------------------------------------------------------------------------------|-----------------------------------------------------------------------------------|-----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| 2Cool™                                                                            | F-PFS™                                                                            | PowerTrench®                                                                      | The Power Franchise®                                                                |
| AccuPower™                                                                        | FRFET®                                                                            | PowerXS™                                                                          | the power®                                                                          |
| AX-CAP™*                                                                          | Global Power Resource™                                                            | Programmable Active Droop™                                                        | franchise™                                                                          |
| BitSiC®                                                                           | Green Bridge™                                                                     | QFET®                                                                             | TinyBoost™                                                                          |
| Build it Now™                                                                     | Green FPS™                                                                        | QS™                                                                               | TinyBuck™                                                                           |
| CorePLUS™                                                                         | Green FPS™ e-Series™                                                              | Quiet Series™                                                                     | TinyCalc™                                                                           |
| CorePOWER™                                                                        | Gmax™                                                                             | RapidConfigure™                                                                   | TinyLogic®                                                                          |
| CROSSVOLT™                                                                        | GTO™                                                                              | TM                                                                                | TINYOPTO™                                                                           |
| CTL™                                                                              | IntelliMAX™                                                                       |  | TinyPower™                                                                          |
| Current Transfer Logic™                                                           | ISOPANAR™                                                                         | Saving our world, 1mW/W/kW at a time™                                             | TinyPWM™                                                                            |
| DEUXPEED®                                                                         | Marking Small Speakers Sound Louder and Better™                                   | SignalWise™                                                                       | TinyWire™                                                                           |
| Dual Cool™                                                                        | MegaBuck™                                                                         | SmartMax™                                                                         | TranSiC®                                                                            |
| EcoSPARK®                                                                         | MICROCOUPLER™                                                                     | SMART START™                                                                      | TriFault Detect™                                                                    |
| EfficientMax™                                                                     | MicroFET™                                                                         | Solutions for Your Success™                                                       | TRUECURRENT®*                                                                       |
| ESBC™                                                                             | MicroPak™                                                                         | SPM®                                                                              | uSerDes™                                                                            |
|  | MicroPak2™                                                                        | STEALTH™                                                                          |  |
| Fairchild®                                                                        | MillerDrive™                                                                      | SuperFET®                                                                         | UHC®                                                                                |
| Fairchild Semiconductor®                                                          | MotionMax™                                                                        | SuperSOT™-3                                                                       | Ultra FRFET™                                                                        |
| FACT Quiet Series™                                                                | Motion-SPM™                                                                       | SuperSOT™-6                                                                       | UniFET™                                                                             |
| FACT®                                                                             | mWSaver™                                                                          | SuperSOT™-8                                                                       | VCX™                                                                                |
| FAST®                                                                             | OptoHit™                                                                          | SupreMOS®                                                                         | VisualMax™                                                                          |
| FastvCore™                                                                        | OPTOLOGIC®                                                                        | SyncFET™                                                                          | VoltagePlus™                                                                        |
| FETBench™                                                                         | OPTOPLANAR®                                                                       | Sync-Lock™                                                                        | XS™                                                                                 |
| FlashWriter® *                                                                    |  |  |                                                                                     |
| FPS™                                                                              |                                                                                   |                                                                                   |                                                                                     |

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| Datasheet Identification | Product Status        | Definition                                                                                                                                                                                          |
|--------------------------|-----------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Advance Information      | Formative / In Design | Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.                                                                       |
| Preliminary              | First Production      | Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design. |
| No Identification Needed | Full Production       | Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.                                               |
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Rev. I61



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- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.